Connecting thermoelectric performance and topological-insulator behavior: Bi₂Te₃ and Bi₂Te₂Se from first principles

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Thermoelectric performance is of interest for numerous applications such as waste heat recovery and solid state energy conversion, and will be seen to be closely connected to topological insulator behavior. In this context we here report first principles transport and defect calculations for Bi_2Te_2Se in relation to Bi_2Te_3 . The two compounds are found to contain remarkably different electronic structures in spite of being isostructural and isoelectronic. We discuss these results in terms of the topological insulator characteristics of these compounds.

I. INTRODUCTION

Thermoelectric performance is typically quantified in term of a dimensionless figure-of-merit ZT, given by the following expression:

$$ZT = \frac{S^2 \sigma T}{\kappa} \tag{1}$$

Here S is the Seebeck coefficient or thermopower, σ is the electrical conductivity, T the absolute temperature, and κ the thermal conductivity. The expression shows that for good performance one desires both high electrical conductivity and Seebeck coefficient, but these are difficult to obtain simultaneously due to opposite dependencies on carrier concentration. Hence thermoelectric performance is a counter-indicated property of materials that does not commonly occur, and determining and optimizing a usable high performance thermoelectric material remains a difficult challenge.

Thermoelectric performance is of considerable engineering and technological importance due to the many potential applications of this technology, which include vehicular exhaust waste heat recovery, energy harvesting, heating and cooling, and solid state energy conversion. In all of these applications higher thermoelectric performance would be extremely beneficial for enhanced device performance. Currently, there are relatively few thermoelectrics with ZT values above unity, the minimum necessary for a thermoelectric to be considered high performance. This has greatly limited the utility of thermoelectrics, leading to substantial efforts aimed at raising ZT.

Presently the thermoelectric most employed in applications is Bi_2Te_3 , a narrow gap semiconductor which shows optimized ZT figures of approximately unity at ambient temperature. It is presently used primarily in niche applications.

Of great consequence for potential applications, at temperatures above 300 K, the performance of Bi_2Te_3 degrades rapidly due to bipolar conduction, or the excitation of carriers of both positive and negative charge. This causes the thermopower to decrease with increasing temperature, the opposite of the usual situation, and in addition causes large increases in the electronic thermal conductivity. Both of these effects are destructive for thermoelectric performance, as suggested by Eq. 1. These effect generally occurs when the semiconductor band gap (about 0.15 eV in Bi_2Te_3) is not sufficiently large relative to the device operating temperature. In the absence of bipolar conduction, ZT is a strongly increasing function of increasing temperature, with performance ultimately limited only by the decomposition or melting point of the material.

 Bi_2Te_3 , therefore, could be an extremely high performance thermoelectric at temperatures of 400 to 500 K, if only its band gap were somewhat larger. This would be of great practical importance given that two major potential applications - exhaust waste heat recovery and solid state thermophotovoltaic conversion - operate at temperatures around 500 K. Part of this work will explore a potential scenario for achieving this.

While Bi_2Te_3 has been known as a high performance thermoelectric for several decades, it also forms the basis for a family of topological insulators (TI) $(Bi,Sb)_2(Te,Se)_3^1$. Many have observed a connection between these two properties, and various explanations proposed; perhaps the simplest one is the observation that good thermoelectrics are usually heavy atomic mass, small band gap semiconductors, as the heavy atom helps to induce low lattice thermal conductivity, as well as the TI band inversion (via spin-orbit coupling), and the small band gap high carrier mobility. A floor on the degree of band inversion necessary to produce TI is set by the band gap, presumably making large band gap TI's less common.

However, not every, or even a significant fraction of heavy mass small gap materials, are good thermoelectrics or good TI materials. Furthermore, some materials without heavy mass atoms or small gaps are excellent thermoelectrics, such as



FIG. 1. Depiction of the effects of spin-orbit coupling in generating topologically insulating, potential high performance thermoelectrics, by means of opening of a gap in the electronic structure, with associated non-parabolicity. A material doped p-type is depicted.

 $Mg_2(Si,Sn)$ and Si-Ge. In addition, from an electronic point of view TI behavior is of interest for an undoped material (where the Fermi energy is in the gap) while high thermoelectric performance is usually observed with the Fermi energy doped into the bulk bands.

Like thermoelectric performance, topologically insulating behavior is of considerable practical importance due to its potential for technological applications, such as memory applications for computers². Here we show a clearer connection between topologically insulating behavior and thermoelectric performance. Briefly, we will see that complex, nonparabolic band structures are favorable both for TI behavior and high thermoelectric performance. In this work we will see that two materials studied as topological insulators - Bi_2Te_3 and Bi₂Te₂Se - appear to have very complex band structures that are in general highly beneficial for thermoelectric performance. These complex band structures are related to TI behavior, as the band inversion necessary for this generally creates complex band structures not typically describable in terms of the usual anisotropic effective mass approximation. Remarkably, the two compounds are very different in the near band edge electronic structures leading to very different transport behavior.

In Figure 1 we depict schematically the effects of spinorbit coupling in producing the complicated band structures just mentioned. Briefly, the band inversion central to TI behavior is induced by spin-orbit coupling, which then opens a gap at the points where the bands would otherwise cross. As depicted in Figure 1, this generally leads to non-parabolic behavior, often with near-linear Kane band-type dispersions. Thus a single, parabolic, non-degenerate band edge, as shown in the left side of this figure, evolves into a non-parabolic, complex, degenerate band edge, as is often observed in highperformance thermoelectrics. More detailed discussions of these effects can be found in Refs. 3–5.

 Bi_2Te_3 exhibits the band inversion required for topologically insulating behavior, but is inconvenient for studying TI. This is because of its small band gap and small defect formation energies, which mean that low bulk electrical conductivity - a prerequisite for observing the topologically protected surface states - is difficult to attain. This is due both to large bipolar conduction, in the lightly doped intrinsic regime and large band conduction (in the heavily doped extrinsic regime favored by the low vacancy formation energies). This small band gap also presents a substantial hindrance to thermoelectric applications above room temperature, as bipolar conduction is highly destructive to thermoelectric performance.

Perhaps with this small band gap in mind, significant recent efforts have been focused on the topologically insulating properties of the isoelectronic and isostructural Bi_2Te_2Se , (experimental band gap of ~ 0.30 eV) where one of the Te layers (see Fig. 2) is entirely replaced with Se. Relatively recently,¹ low bulk conductivity single crystals of this material were synthesized and studied, a major step forward towards the experimental verification of the surface states. To date, however, relatively little attention has been directed to the *thermoelectric* properties of this compound. Indeed, its larger band gap suggests a propensity for thermoelectric performance at temperatures above those of Bi_2Te_3 . Disordered alloys near this composition appear to show some potential for thermoelectric performance at higher temperatures, but not as high as if the low T behavior of Bi_2Te_3 could be extended to higher T.

 Bi_2Te_2Se forms with a structure closely related to that of Bi_2Te_3 . In particular, as shown in Fig. 2, it has a tetradymite type rhombohedral (spacegroup 166) crystal structure, consisting of Bi_2Te_2Se layers stacked along the *c*-axis and separated by van der Waals gaps. These Bi_2Te_2Se layers are the same as the Bi_2Te_3 layers comprising Bi_2Te_3 except that the central Te plane is replaced by a Se plane.^{6–8} Presumably this particular substitution is favored by the fact that placing Se on this site places this more electronegative atom on the site with the best metal coordination.

The growth of high quality crystals of this material has recently been perfected, enabling experimental study of its topological insulating behavior.^{1,9} The compound naturally forms n-type from the melt. However, recent experiments have shown control of the carrier concentration using Sn doping (which introduces mid-gap states) and excess Bi.^{1,9,10}

The thermoelectric properties of Bi₂Te₂Se were recently investigated by Fuccillo and co-workers.¹¹ There has also been recent theoretical and experimental work on the potential performance of nanostructured Bi₂Se₃ and its alloys with Bi₂Te₃.^{12,13} These studies find that Bi₂Se₃ and compounds between it and Bi₂Te₃ can have higher *p*-type thermopowers than Bi₂Te₃ especially at temperatures above the operating temperature of Bi₂Te₃, suggesting a propensity for enhanced *p*-type performance at these temperatures. These studies also suggest that reasonable thermoelectric performance is possible with reduction of the thermal conductivity by nanostructuring.

II. ELECTRONIC STRUCTURE CALCULATIONS

We performed the present calculations using Boltzmann transport theory with the first principles electronic structure, employing the constant scattering time approximation (see Ref. 14 for a detailed description of this approximation.) The BoltzTraP code¹⁵ was used for these transport calculations, and the electronic structure obtained using the modified Becke-Johnson potential of Tran and Blaha (TB-mBJ).¹⁶ This potential gives very much improved band gaps for simple semiconductors and insulators as compared to standard densitv functionals.¹⁶⁻²¹ These calculations employed the general potential linearized augmented planewave (LAPW) method,²² as implemented in the WIEN2k code.²³ Experimental lattice parameters, $(a=4.3792 \text{ Å}, c=30.481 \text{ Å} \text{ for Bi}_2\text{Te}_3 \text{ and } a=4.305$ Å, c=30.00 Å for Bi₂Te₂Se)⁸ were used. The free internal atomic coordinates were determined by total energy minimization using the local density approximation (LDA).

The LDA was used because it was found to yield better structural and vibrational properties for Bi_2Te_3 than generalized gradient approximations when used with fixed lattice parameters for Bi_2Te_3 .²⁴ The structure relaxation was done treating relativity at the scalar relativistic level, as relaxation including spin-orbit coupling is not supported in WIEN; the



FIG. 2. Depiction of the crystal structure of Bi_2Te_2Se , showing the layer stacking along the rhombohedral *c*-axis. The bracket "[" indicates a single Bi_2Te_2Se layer with Se in the central plane. The atomic positions are taken from the relaxed structure.

effect of this omission is likely minimal. All the other reported results include spin-orbit coupling, including the electronic structures and transport properties. Well converged basis sets, defined by a cut-off RK_{max} =9.0 for the planewave vector plus local orbitals for the semi-core *d* states were used. Here k_{max} is the planewave cut-off and *R* is the sphere radius, which was taken as 2.5 bohr for all atoms.

The calculated band gaps are 0.14 eV for Bi₂Te₃ and 0.22 eV for Bi₂Te₂Se. Thus the band gap of Bi₂Te₂Se is significantly larger than that of Bi₂Te₃, although still smaller than that of the higher temperature thermoelectric PbTe (0.36 eV, by a similar method).²⁵ Experiment also shows a similar increase in band gap when Se is added to Bi₂Te₃, i.e. the optical absorption edge is reported to increase from ~ 0.15 eV in Bi₂Te₃ to ~ 0.30 eV at a composition Bi₂Te₂Se.²⁶

Hinsche and co-workers²⁷ reported Boltzmann transport calculations for Bi_2Te_3 . They found results similar to ours for the thermopower and conductivity, and in particular found better conductivity for the in-plane directions and higher values of the thermopower for *p*-type doping.

We present the calculated band structure for both materials in Figure 3. Although some of the features, such as the valence bands more than 0.5 eV below the valence band maximum, are similar the fine details of the electronic structure are in fact very different. For example, both band extrema for Bi₂Te₃ are at off-symmetry locations (the Bi₂Te₃ valence band maximum V is approximately (2/5,2/5,1/3) in the rhombohedral basis, a non-symmetry point), while both extrema for Bi₂Te₂Se are at the Γ point. This has important implications for thermoelectric performance as the increased band degeneracy of Bi₂Te₃ is one likely contributor to its high thermoelectric performance. The valence band of Bi₂Te₃ has two subsidiary maxima located near the Z point, while Bi₂Te₂Se



FIG. 3. The calculated band structure of Bi_2Te_3 and Bi_2Te_2Se . We have set the energy 0 to be the valence band maximum for both materials. The point "V" refers to the approximate location of the valence band maximum of Bi_2Te_3 - (2/5,2/5,1/3) in the rhombohedral basis, and L' to the point (0,0,-1/2) in the same basis.



FIG. 4. The calculated band structures of Bi_2Te_3 and Bi_2Te_2Se with the spin-orbit coupling included in strengths (relative to the actual physical value) of 0, 0.25, 0.5, 0.75 and unity.

has two subsidiary valence band local maxima located at different points.

One plausible question to ask, given the argument of the Introduction for the correspondence between the complex band structures favorable for both thermoelectric performance and topological insulators, is the relationship of the above band structures to spin-orbit coupling. In order to address this question we present in Figure 4 the results of calculations in which the effective strength of the spin-orbit coupling is varied from zero to unity (the fully spin-orbit case). As the plots indicate, without spin-orbit both materials are direct gap semiconductors with band edges at the Γ point and comparatively



FIG. 5. The calculated isoenergy surfaces of Bi_2Te_3 and Bi_2Te_2Se . The energies given represent the isoenergy value, relative to the respective band extrema.

parabolic bands. In both cases, however, as the spin-orbit interaction is turned on the band gap decreases radically until in the strength=0.75 plot the gap is very small - less than a tenth of an eV, and the bands become visibly non-parabolic. Finally, as in the right-hand panel of Figure 1, when the full strength of spin-orbit is applied a new gap opens up - between the Z and Γ points for Bi₂Te₃ but returning to the Γ point for Bi₂Te₂Se, and these band structures do appear to be comparatively non-parabolic. Note also that the motion of the band edges in Bi₂Te₃ away from the Γ point with the advent of spin-orbit automatically implies a more complex Fermi surface structure due to the associated degeneracy, irrespective of the parabolicity of the bands.

By way of comparison, the band structure of Bi₂Te₂Se is in fact much more similar to that of Bi₂Se₃, which also has both extrema at the Γ point, than that of Bi₂Te₃, despite being closer to the latter compound compositionally. Further insight can be obtained by plotting the isoenergy surfaces of both materials, as presented in Figure 5. For both materials, for *p*-type doping a highly anisotropic, non-parabolic behavior is evident. Recall that in a parabolic approximation the isoenergy surfaces takes the form of ellipsoids of revolution, even if effective mass anisotropy is considered. Neither of these materials exhibits a p-type Fermi surface at all resembling an ellipsoid; for Bi₂Te₃ at the smallest energies a distinct triangular shape appears, followed at increasing binding energy by a bell-like structure and ultimately augmented with planar "wings". The shape is very different for Bi₂Te₂Se, with the initial VBM at Γ rapidly evolving into an "X" shaped figure (note that there are in fact 6 subsidiary extrema in this structure), which is then followed by a ring-like feature.

All of these deviations from spherical, or ellipsoidal, shapes can be seen to be beneficial for thermoelectric performance. For a given volume (in this case effectively carrier concentration), a sphere has the minimum surface area (in this case, effectively density-of-states [DOS]), and therefore minimum thermopower, since in the degenerate limit the thermopower is proportional to the DOS mass. Hence all deviations from a spherical isoenergy surface enhance the thermopower, and the greater the deviation the greater the enhancement. An example of this effect can be found in Ref. 28. While a detailed quantitative comparison between the two materials on this basis is not readily available, we may state with some confidence that *both* materials, when doped p-type will benefit from the anisotropy of the electronic structure.

With regards to *n*-type, here the situation is substantially different. While Bi_2Te_3 still affords a substantially anisotropic isoenergy surface, with a discus shape evolving out of a non- Γ point extremum, for Bi_2Te_2Se there is only a single Γ -centered, relatively cylindrical extremum, and this cylindrical shape is notably "closer" to a spherical shape than that of Bi_2Te_3 . Hence we expect, and will later see, diminished *n*-type performance for Bi_2Te_2Se relative to Bi_2Te_3 .

We note that all band structures are significantly different from the "pudding-mold" band structure proposed by Kuroki et al²⁹ as an explanation for the simultaneous occurrence of high thermopower and electrical conductivity in the cobalt ate $Na_x CoO_2$. In that band structure a flat upper portion provides the large density-of-states necessary for a high Seebeck coefficient, while a dispersive portion connecting to this provides a light band which favors high conductivity. Here Bi₂Te₃ in particular, from Figs. 3 and 5, contains near-degenerate band edges resulting from its complex isoenergy surfaces that allow it to attain high conductivity without sacrificing thermopower, a distinct scenario from that of Ref. 29.

Although it is not immediately apparent from the plots, the iso-energy surfaces reflect the rhombohedral symmetry, with the off-symmetry valence band maximum for Bi₂Te₃ six-fold degenerate and the conduction band minimum located on the trigonal axis two-fold degenerate. For *p*-type Bi₂Te₂Se, the "X" emanating from the Γ point (beginning at -0.05 eV) actually comprises six "arms", as two of the "arms" are hidden by the projection.

III. BOLTZMANN TRANSPORT CALCULATIONS

Following the electronic structure calculations, we performed Boltzmann transport calculations of the doping and temperature-dependent thermopower and electrical conductivity, within the "constant scattering time approximation", which shows substantial success in describing thermopower of a large number of materials. Within this theory of diffusive transport the expressions for the thermopower and conductivity are

$$S = \frac{\int dE\sigma(E)(E - E_F)f'(E - E_F)}{\int dE\sigma(E)f'(E - E_F)},$$
(2)

and



FIG. 6. Conductivity averaged Seebeck coefficient as a function of carrier concentration for Bi₂Te₃ (solid lines) and Bi₂Te₂Se (dashed lines) for *p*-type (above zero line) and *n*-type doping (below zero line) levels. The horizontal blue lines indicate a thermopower magnitude of 200 μ V/K, generally the minimum necessary for a material to be a high performance thermoelectric.

$$\sigma = \int dE \sigma(E) f'(E - E_F), \qquad (3)$$

where f' is the energy derivative of the Fermi function and $\sigma(E)$ is the energy dependent transport function related to conductivity, $N(E) < v^2(E)\tau(E) >$, N(E) the density of states, v^2 the square of the component of the band velocity on the direction of the interest (i.e. v_x for conductivity along direction x, making v^2 a rank 2 tensor, like the conductivity), τ the inverse scattering rate. The constant scattering time approximation is the neglect of the energy (but not doping or temperature) depedence of τ , so that the transport function becomes $N(E) < v^2(E) > \tau$, where $< v^2 >$ is the average Fermi velocity (still a rank 2 tensor).

With these preliminaries completed, we move to the calculated quantities of interest. In Figure 6 we present the thermopower for the two materials, at three temperatures - 300, 400 and 500 K. Note that due to the anisotropy of the electronic structure we have depicted the conductivity weighted thermopower, as would be observed in the polycrystalline sample typically measured in the experiment. For p-type, one notes that the thermopower is significantly larger for Bi_2Te_2Se than for Bi₂Te₃, as a function of carrier concentration, for all three temperatures. This reflects the differing electronic structure of these two materials, as well as the larger calculated band gap of Bi_2Te_2Se . At all three temperatures, *p*-type Bi₂Te₂Se displays a substantial range of carrier concentration where the thermopower is larger than 200 μ V/K. As we have noted elsewhere³⁰, the Wiedemann-Franz relation essentially necessitates a thermopower magnitude of 200 μ V/K or greater for a high performance thermoelectric; it is worth noting that this is the 300 K thermopower of optimally doped Bi₂Te₃. For n-type the thermopower of Bi_2Te_2Se appears inferior to that of Bi_2Te_3 , even with the larger band gap, presumably due to the less anisotropic, and hence less non-parabolic electronic structure. We therefore focus on p-type behavior in the following.

The benefits of Bi_2Te_2Se relative to Bi_2Te_3 in the *p*-type thermopower should not, however, necessarily be taken as quantitative evidence for likely better, or even equal, thermoelectric performance in Bi₂Te₂Se. In order to assess this we plot the average electrical conductivity versus thermopower at 300 K in Figure 7. Figure 7 reveals that in the *p*-type (right hand side of plot) region of thermopower around 200 μ V/K, the two materials have virtually identical σ/τ , which would indicate comparable thermoelectric transport, if the scattering times are equal. The same behavior is evident at 500 K (not shown). Note that in this comparison we are not referring to the bottom portion of the graphs, near where the thermopower transitions from positive to negative. This region is firmly within the bipolar regime, well below optimal doping, and for which thermoelectric performance is generally poor. Instead we refer to the linear region adjacent to the legend, which is likely near where optimal performance would be found.

The isoenergy surfaces for *p*-type Bi₂Te₂Se appear to be somewhat less anisotropic than for Bi₂Te₃, which may explain why the thermopower benefits versus carrier concentration do not remain when compared to σ/τ . With regards to τ , the scattering times may not be equal, given that in one sample of the line compound Bi₂Te₂Se disorder¹ of order 5 percent was observed on the Te/Se sites, which would tend to decrease scattering times and hence electrical conductivity. Optimal electrical conductivity in Bi₂Te₂Se therefore may necessitate extremely careful sample preparation in order to minimize this effect.

For a further comparison, in Fig. 8 we depict the calculated power factor $S^2\sigma/\tau$ (with respect to an average, unknown scattering time) at 300 K for both materials, for *p*-type and *n*-type, as a function of carrier concentration (carriers per unit cell). The plot depicts comparable behavior for *p*-type, consistent with the behavior in Figures 6 and 7, noting that shorter scattering times in Bi2Te₂Se may degrade the performance of this material relative to that of Bi₂Te₃. For *n*-type this figure suggests, consistent with the other figures, that Bi₂Te₂Se performance will significantly lag that of Bi₂Te₃.

Returning to Figure 6, p-type Bi₂Te₃ shows doping levels where the thermopower is above 200 μ V/K at temperatures above 300 K, where thermoelectric performance is usually believed to deteriorate. This is most significant at 400 K but is true even at 500 K. This means good thermoelectric performance may obtain at these temperatures. Actual results, particularly at 500 K, will depend sensitively on the exact value of the band gap at these temperatures, as well as on any differences in hole and electron scattering times. Performance would likely be optimized at dopings significantly heavier than those (about $p = 2 \times 10^{19} \text{ cm}^{-3}$) used for commercial Bi₂Te₃. This is necessary to minimize bipolar conduction. At 400 K this doping level is approximately 4×10^{19} cm^{-3} and at 500 K it is 5.8 $\times 10^{19}$ cm⁻³. Due to the close proximity of the bipolar regime performance will rapidly degrade at dopings below these. For *n*-type there is no such region of extended higher temperature performance for either



FIG. 7. Average 300 K conductivity versus Seebeck coefficient for Bi_2Te_3 (dashed lines) and Bi_2Te_2Se .



FIG. 8. Average 300 K power factor $S^2 \sigma / \tau$ versus doping level for Bi₂Te₃ (solid lines) and Bi₂Te₂Se.

Bi₂Te₃ or Bi₂Te₂Se.

Figures 6, 7 and 8 together suggest that the likelihood of Bi_2Te_2Se performance exceeding that of Bi_2Te_3 is fairly low, even at the elevated temperatures where its larger band gap would be expected to be of advantage. This has implications for the ongoing search for technologically useful thermoelectrics in the 400 to 500 K range, in particular suggesting that a larger band gap cannot necessarily be considered a panacea for achieving high thermoelectric performance. In this case it is the less favorable electronic structure of Bi_2Te_2Se relative to Bi_2Te_3 that is the source of the difficulty, suggesting that even closely related materials are not necessarily equivalent from the standpoint of thermoelectric performance.

We note that, presumably due to the weakly bonded van der Waals layers in both these materials, the lattice parameters determined from a first principles optimization can differ significantly from the experimental lattice parameters used in the foregoing calculations (See Table 1 for the actual values). Given this, it is natural to perform an assessment of the effects



FIG. 9. Planar thermopower values for Bi_2Te_3 and Bi_2Te_2Se , using both the experimental and theoretical lattice parameters.

of such differences on electronic structure and on the transport quantities depicted in the above plots. We depict such a comparison in Fig. 9 above, for the planar thermopower at 300 K. For *p*-type, the results depict a marginal decrease in Bi_2Te_3 thermopower, and equally marginal increase in Bi₂Te₂ thermopower; the main effect of the smaller theoretical lattice parameters is in fact an increase in the calculated band gap of Bi_2Te_2Se by approximately 0.06 eV. This change, however, only affects the thermopower for Bi2 Te2Se at dopings around 10^{18} cm⁻³, far below optimal doping, so for the purposes of assessing thermoelectric performance the effects on *p*-type of the theoretical lattice parameters are essentially nil. With regards to *n*-type, the effects of the experimental lattice parameters are somewhat larger, but are of similar magnitude (and the same sign) for both materials, so that on a comparative basis here too the effects are rather small. Finally, we note use of the experimental lattice parameters generally gives better agreement with experiment in these van der Waals materials and so retain their usage for the electronic structure calculations presented here.

IV. LATTICE DYNAMICS CALCULATIONS

Lattice dynamics, or phonon band structure and transport, ultimately determines the lattice thermal conductivity, a key quantity affecting thermoelectric performance. To this end we have performed lattice dynamics calculations for Bi₂Te₂Se, using density functional theory in Blöchl's projector augmented-wave (PAW) method within the LDA as implemented in VASP. A $3 \times 3 \times 3 k$ -point grid in a $3 \times 3 \times 3$ supercell was used, along with an energy cutoff of 300 eV. Cell parameters and internal coordinates were both relaxed until internal forces were less than 2 meV/Å. The optimized lattice constants for Bi₂Te₂Se are a=4.265 Å and c=29.328 Å.

In Figures 10 and 11 we present the phonon band structure and site-projected density of states for Bi_2Te_2Se . Note that in Figures 10 and 11 we also include a band structure and density-of-states for Bi_2Te_3 calculated from one of our previ-



FIG. 10. Computed phonon band structure for Bi_2Te_2Se (top) and Bi_2Te_3 (bottom) from Ref. 24.Coordinate of the high symmetry points are (in units of the rhombohedral lattice vector) L:(1/2,0,0); F(1/2,0,1/2); Z:(1/2,1/2,1/2).

ous works, using the same methods. We immediately note a great similarity in the phonon bandstructures, with the main difference being slightly larger frequencies in Bi₂Te₂Se and a somewhat larger gap in the 2 - 2.5 Thz region in Bi₂Te₂Se. It is noteworthy that the phonon band structures are so similar while the electronic band structures are so different. Part of this is that phononic transport tends to be less variable than electronic, but a more fundamental reason is that for thermoelectrics and topologically insulators, only the region near the band extrema is of relevance and these can clearly vary more widely than the entire electronic structure. The sound speeds for Bi_2Te_2Se are somewhat higher than for Bi_2Te_3 - in the nearly planar Γ -L direction the Bi₂Te₂Se sound speeds (transverse modes first) are 1524, 1763 and 2500 m/sec while the corresponding values for Bi₂Te₃ are 1395, 1728, and 2394 m/sec. For the c axis Γ -Z direction the values for Bi₂Te₂Se are 1781 (degenerate transverse mode) and 1994 m/sec, and the corresponding values for Bi₂Te₃ are 1774 and 1811 m/sec. The significantly lighter mass of Se relative to Te is likely responsible for the higher phonon frequencies and sound speeds of Bi₂Te₂Se.

Given the higher sound speeds, the lattice thermal con-



FIG. 11. Computed phonon density-of-states for Bi_2Te_2Se (top) and Bi_2Te_3 .

ductivity of Bi_2Te_2Se may be somewhat higher than that of Bi_2Te_3 . Note, however, that the sound speeds for Bi_2Te_2Se are still comparatively low, so that fairly low lattice thermal conductivity can be expected in the Bi_2Te_2Se material. The lower longitudinal c-axis sound speed would suggest somewhat lower thermal conductivity in this direction than in plane.

Moving to the calculated phonon density-of-states (Fig. 11), we note immediately the prominent Se peak around 3.5 Thz, near the top end of the spectrum. This is reasonable considering the lower mass of Se relative to Te and Bi. The lower frequency modes below 2.5 Thz are most predominantly Bi, which again comports with the extremely heavy mass of Bi. One final point of interest is that there is a nearly complete gap opened around 2.5 Thz. This gap is more prominent than in Bi₂Te₃ and this is again likely a result of the lighter Se atom increasing the frequency of the highest modes found between 2.5 and 4 Thz. This also can be seen in Figure 10, where for Bi₂Te₂Se there is a gap of approximately 0.3 Thz at the Γ point but essentially no gap at this point in Bi₂Te₃.

It is of interest to compare the behavior of the Se atom partial DOS in Bi_2Te_2Se in Fig. 11 (top) with that of Te1 in Bi_2Te_3 in Fig. 11 (bottom), since these two atoms occupy

TABLE I. The lattice constants we use in this work.

	Bi^a	Se^b	Te^{c}	$\mathrm{Bi}_2\mathrm{Se}_3{}^d$	Bi ₂ Te ₃	Bi ₂ Te ₂ Se
<i>a</i> Experimental	4.546	4.368	4.458	4.135	4.379	4.305
<i>c</i> Experimental <i>a</i> Theoretical	11.862	4.958	5.925	28.615	30.481 4.350	30.00 4.265
c Theoretical					29.82	29.33

^a experimental value in Ref.³¹ ^b experimental value in Ref.³² ^c experimental value in Ref.³³

^dexperimental value in Ref.³⁴

the same between-layer site (see Fig. 2). As the Figure indicates, the Te1 DOS is almost entirely (excepting the acoustic regime) comprised of a single peak around 2.7 GHz, while the Se DOS is comprised of three separate peaks at 3, 3.5 and 3.8 GHz. All these Se peaks energies are higher than the Te1 peak in Bi₂Te₃,, as expected given the lighter mass of Se, but the split in these Se peaks is of interest. We suspect its origin is the effectively more complex physical structure of Bi₂Te₂Se in containing three distinct atomic masses rather than two, which splits what would otherwise be a more singular peak.

V. DEFECT ENERGY CALCULATIONS AND PHASE STABILITY

It is well known that Bi_2Te_3 tends to form off stoichiometry due to low anti site defect formation energies. Within this context it is of interest to consider the defect formation energies in Bi_2Te_2Se as these will provide important information about the nature and magnitudes of defect formation, and associated scattering, in this material. We limit ourselves to Se/Te antisite defects as due to the equivalent charge count these energies are expected to be especially low.

These defect calculations, as with the lattice dynamics calculations, are based upon density functional theory in the framework of Blöchl's projector augmented-wave (PAW) method within the local density approximation (LDA) as implemented in VASP. We use a $4 \times 4 \times 1$ conventional hexagonal unit cell containing 240 atoms, and the $2 \times 2 \times 1$ Monkhorst-Pack *k*-point grid together with an energy cutoff of 500 eV. The force convergence criterion acting on atoms is less than 0.01 eV/Å. The experimental lattice constants are used for Bi₂Te₂Se, Bi₂Te₃, Bi₂Se₃, Bi, Se, and Te as listed in Table I.

For the defect calculations, the formation energies ΔH for defect in the charge state q are given by

$$\Delta H_{D,q}(E_F,\mu) = (E_{D,q} - E_H) + \sum_{\alpha} n_{\alpha} (\Delta \mu_{\alpha} + \mu_{\alpha}^{solid}) + q(E_v + E_F).$$
(4)

Since we only concern ourselves with the Se_{Te} and Te_{Se} antisite defects with the same valence states, q equals 0. In the first term, $E_{D,q}$ and E_H are the total energies of a solid with



FIG. 12. Calculated ranges of chemical potentials of the elements involved in Bi_2Te_2Se and related competing phases. The range of thermodynamical stability of Bi_2Te_2Se is defined by the trapezoid ABCD.

and without defect D, respectively. The second term represents the energy of the atom of species α added $(n_{\alpha}=-1)$ or removed $(n_{\alpha}=1)$ from a reservoir of that species with chemical potential $\mu_{\alpha} = \Delta \mu_{\alpha} + \mu_{\alpha}^{solid}$.

Under equilibrium conditions for the crystal growth, the chemical potentials μ_{α} must satisfy certain conditions in order to form a stable host compound. Other competing phases (including elemental solids) must be avoided. In order to maintain the stability of Bi₂Te₂Se during growth and avoid competing phases (e.g., Bi, Te, Se, Bi₂Te₃ and Bi₂Se₃), the relative chemical potential $\Delta \mu_{\alpha}$ must satisfy the following limits.

$$2\Delta\mu_{\rm Bi} + 2\Delta\mu_{\rm Te} + \Delta\mu_{\rm Se} = \Delta H({\rm Bi}_2{\rm Te}_2{\rm Se}) = -1.478 \text{eV5})$$
$$\Delta\mu_{\rm Bi} < 0, \Delta\mu_{\rm Te} < 0, \Delta\mu_{\rm Se} < 0. \tag{6}$$

$$2\Delta\mu_{\rm Bi} + 3\Delta\mu_{\rm Te} \le \Delta H({\rm Bi}_2{\rm Te}_3) = -1.123 \text{eV}, \quad (7)$$

$$2\Delta\mu_{\mathrm{Bi}} + 3\Delta\mu_{\mathrm{Se}} \le \Delta H(\mathrm{Bi}_2\mathrm{Se}_3) = -1.964\mathrm{eV}.$$
 (8)

All calculated heats of formation of ternary and binary compounds in this work are given for per formula unit.

Eqs. 5-8 are projected to the two dimensional panel with two independent variables, $\Delta \mu_{\rm Te}$ and $\Delta \mu_{\rm se}$ as shown in Figure 12. The thermodynamically stable ranges of chemical potentials of the elements in Bi₂Te₂Se (trapezium, *ABCD*) are obtained by excluding the regions of chemical potentials in which competing phases are thermodynamically stable as shown in Figure 12.

Our calculated formation energies of antisite Se_{Te} and Te_{Se} are are collected in Table 2, with relative chemical potentials at the corresponding *A*, *B*, *C*, and *D* points in Figure 12.

Figure 12 asserts that Bi_2Te_2Se is only thermodynamically stable within a narrow Te-Se compositional range, above which Bi_2Se_3 would be formed and below which Bi_2Te_3 would be performed. From Table II, we see that certain defect structures, such as Te_{Se} have defect energies as low as 0.041

TABLE II. The calculated defect formation energies for antisite defects Se_{Te} and Te_{Se} with chemical potentials at *A*, *B*, *C*, *D* points.

	А	В	С	D
$egin{aligned} & (\Delta\mu_{\mathrm{Te}},\Delta\mu_{\mathrm{Se}}) \ & \mathbf{Se_{\mathrm{Te}}} \ & \mathbf{Te_{\mathrm{Se}}} \end{aligned}$	(-0.41,-0.65)	(0, -0.24)	(-0.37,-0.73)	(0, -0.36)
	0.115	0.115	0.228	0.228
	0.154	0.154	0.041	0.041

eV. When one considers putative synthesis conditions of 1000 K, this would in equilibrium yield a Te_{Se} defect concentration of order 50 percent, an absurdly large number. Hence it will be important to synthesize under conditions towards the Se-rich side. Even here, though, the defect formation energies are low - 0.115 eV for Se_{Te} defects and 0.154 eV for Te_{Se} defects, both less than twice the thermal energy at 1000 K, so that substantial numbers of defects are likely to be formed at typical synthesis conditions.

There are two main points to be gleaned from these results. Firstly, since the defect formation energies are small and asymmetric, substantial numbers of defects will form and the number of Te_{Se} and Se_{Te} defects will not be equal, so the material will likely form off stoichiometry. Secondly, and more importantly, since the electronic structures of the two compounds Bi_2Te_3 and Bi_2Te_2Se are so different, these large numbers of defects are likely to induce substantial alloy scattering, which is likely to significantly impair mobility. It may also reduce the lattice thermal conductivity, but given that this is already likely to be fairly low, the mobility reduction is likely to be the larger effect.

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VI. CONCLUSION

Topological insulators, such as Bi₂Te₃ and Bi₂Te₂Se considered in this work, of necessity have complex band structures due to the band inversion central to the topologically insulating behavior. These complex band structures, in particular highly non-parabolic isoenergy surfaces, are also those favored by high performance thermoelectrics, and these two studied materials appear to contain such anisotropic features, though rather different in the specifics. The relationship between thermoelectric performance and TI behavior is thus through the band structure as it relates to transport. TI materials necessarily have highly non-parabolic shapes that generally lead to corrugated isoenergy surfaces at the doping levels of interest for thermoelectrics. These corrugated surfaces are favorable for obtaining the combination of high conductivity and high thermopower required in a high performance thermoelectric.

The favorability of complex non-parabolic band structures for *both* TI behavior and high thermoelectric performance suggests that future searches for such technologically promising materials may benefit from a consideration of the degree of complexity and anisotropy of the electronic structure of materials studied. It will be of interest to pursue these potentially useful behaviors from this perspective.

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